

Product/Process Change  
Notifications

Amphenol Information Communication and Commercial Products Group  
[www.amphenol-icc.com](http://www.amphenol-icc.com)

PCN-240228

Product Name:	PCI Express MiniCard, DDR2 DIMM sockets, DDR3 TH, SMT, HPL-507, S&OP= 50VF, 50QF, 50FF, 50EF								
Product Manager:	Bonnie Liu								
Subject:	PCN for EOL products due to life cycle declined and tooling worn out								
Distribution:	H3C, Benchmark, CODICO, R DENSHI, NEC, Fujitsu, Hitachi, Huawei, Siemens, ZTE, Arrow, Avnet, Digikey, NARREL, SPIREN, CISCO, NEC, CEILMT, Hilkvision, GENDYN								
Type of Change:	End of life								
Change Description:	Due to tooling worn out and part declined in application field. Amphenol issue this PCN to EOL below product lines. 1. DDR2 DIMM sockets 2. PCI Express MiniCard 3. DDR3 TH 4. DDR3 SMT  PN list: 10081530, 10005639, 10078239, 10104389, 10074146, 10126551, 10037402, 10079192, 10068597, 10079248, 10068597, 10109498, 10054995, 10054995								
Reason for Change:	Tooling worn out and demand is declined or customer project EOL.								
Affected Parts:	See above PN list								
Effective Date of Change:	July 1, 2024								
Earliest Change Date:	May 15, 2024								
Earliest Disty Return Date:	April 30, 2024								
Last Time Shipment Date	June 30, 2024								
Datasheet Attached?	Send per request								
Qual/Test Data Attached?	Send per request								
Samples Availability Date:	N/A								
Available Alternatives?	N/A								
Questions?	Contact your local AICC Representative, or Product Manager <a href="mailto:Bonnie.liu@fci.com">Bonnie.liu@fci.com</a> +86 769 88669459								

Note:  
Customers should contact Product Manager (or their local AICC Representative) directly regarding any concern on the PCN.  
Lack of any such customer feedback within three weeks of PCN release date will be interpreted as non-objection .

Form: FTF-ELX-02-001

Revision: D

Guardian: PCN Coordinator